



广州市东裕光电科技有限公司

产品规格书 SPECIFICATION

客户名称 CUSTOMER	
产品名称 PRODUCTION	红外接收头 Infrared Receiver Module
产品型号 MODEL	DY-IRMHF384-T05-2.5KB
版本号 VERSION NO	A1.0

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DY-IRMHF384-T05-2.5KB



产品描述 Descriptions

- DY-IRMHF384-T05-2.5KB 是一款用于遥控和其他需要改善环境光抑制的应用微型红外接收器件。此器件内含一个光电接收二极管和一个前置放大 IC，集成在一个支架上，包裹在外面的环氧树脂可以过滤特殊的红外光，即使在受干扰的环境光中使用，此器件也具有出色的性能，并针对不受控制的输出脉冲提供保护。
(The DY-IRMHF384-T05-2.5KB is miniaturized infrared receivers for remote control and other applications requiring improved ambient light rejection. The separate PIN diode and preamplifier IC are assembled on a single lead frame. The epoxy package contains a special IR filter. This module has excellent performance even in disturbed ambient light applications and provides protection against uncontrolled output pulses.)

产品特性 Features

- 无需外部组件
- 宽工作电压：2.7-5.5V；
- TTL 和 CMOS 兼容性；
- 对各种干扰光和功率噪声有较强抗力（内置滤波器和 AGC 电路）；
- 可用于 32.7 kHz 至 40 kHz 之间的载波频率，（由齐纳管融合，32.7kHz，36.7kHz，37.9kHz，40kHz 调整）；
- 低电平有效；
- 无铅；
- 符合 RoHS 要求；

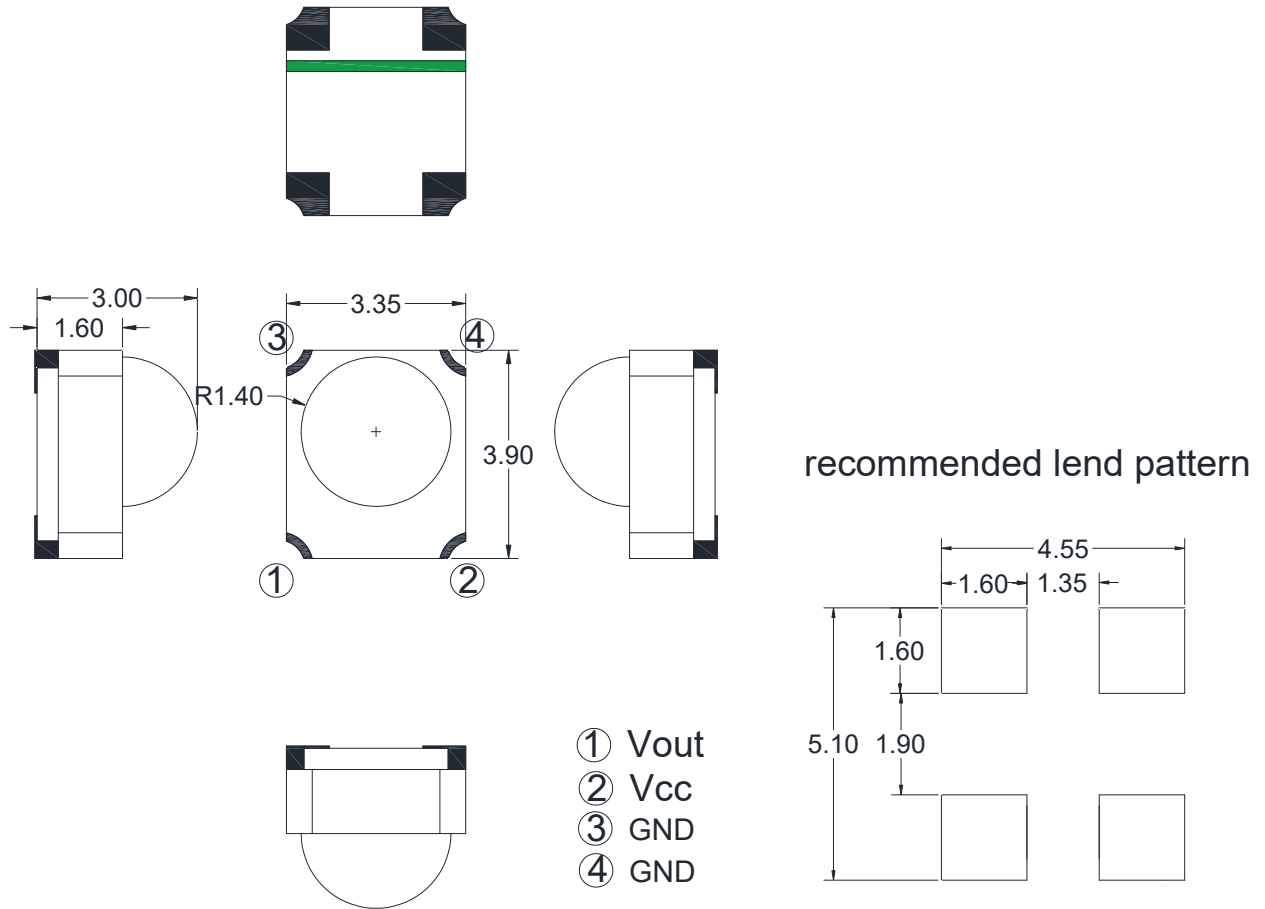
产品应用 Applications

- TV、DVD、机顶盒、风扇等
- 光电开关

包装方式 Packing Quantity Specification

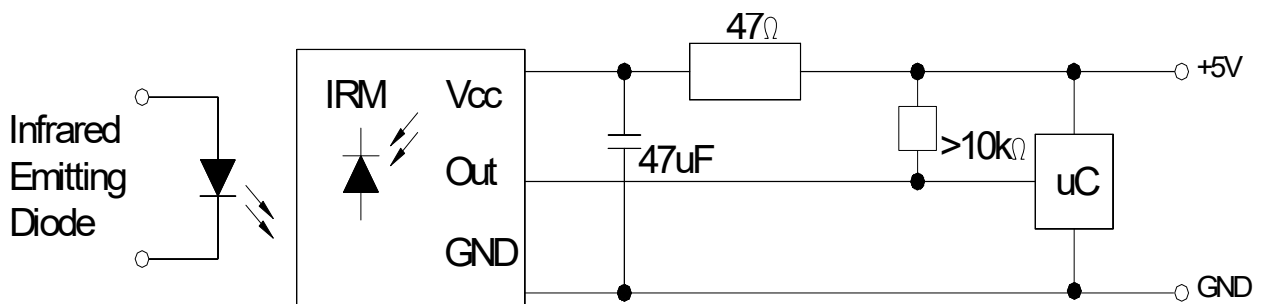
- 2500PCS/卷(2500PCS/reel)

一、外形图 Outline dimensions:

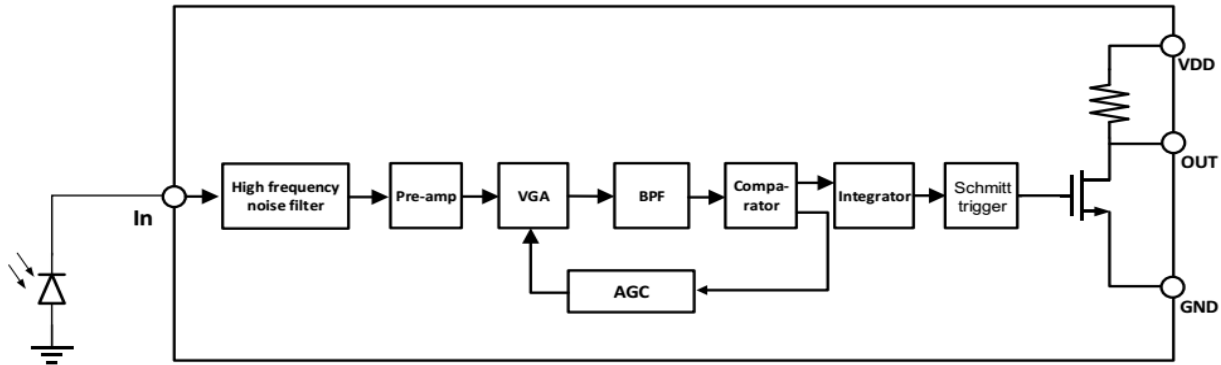


- Notes: 1.All dimensions are in millimeters (inches).
2.Tolerance is $\pm 0.30\text{mm}$ (0.012") unless otherwise specified.
3.Specifications are subject to change without notice.

二、应用电路 Application Circuit



三、功能模块图 Function block diagram



四、光电参数 Electro-Optical Characteristics:

(环境温度 Ambient temperature: 25℃, 环境湿度 Humidity: RH60%)

参数	符号	测试条件	Min	Type	Max	单位
工作电压	Vcc		2.7	-	5.5	V
接受距离	L0	At the ray axis*1	16	-	-	M
	L45		8	-	-	
载波频率	F0		38K			HZ
接收角度	$\theta_{1/2}$	距离衰减 1/2	+/-45			Deg
峰值波长	λ_p		-	940	-	Nm
静态电流	Icc	Vcc=5V No signal input	0.2	0.39	0.58	mA
低电平输出	VoL		-	0.2	0.4	V
高电平输出	VoH		2.7	3.0	-	V
输出脉冲宽度	Tl	At the ray axis *2	400	-	800	μ S
	Th		400	-	800	μ S

注(Notes): *1:The ray receiving surface at a vertex and relation to the ray axis in the range of $\theta=0^\circ$ and $\theta=45^\circ$

*2:A range from 30cm to the arrival distance. Average value of 50 pulses

五、极限参数

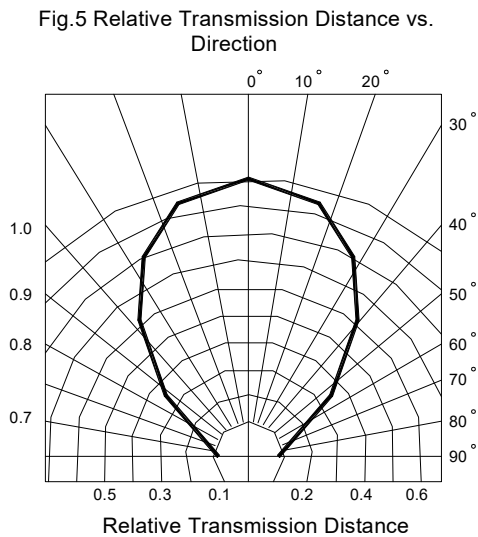
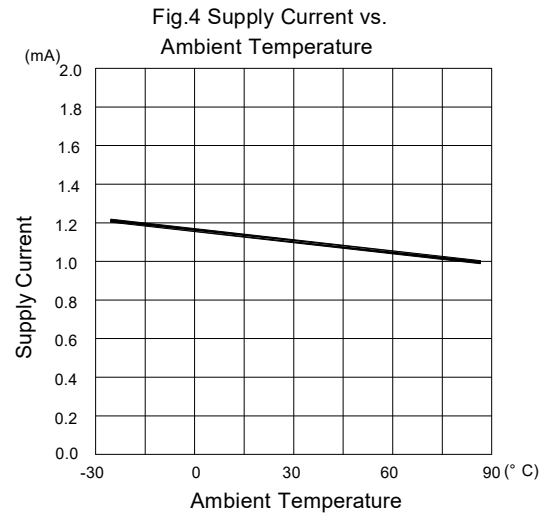
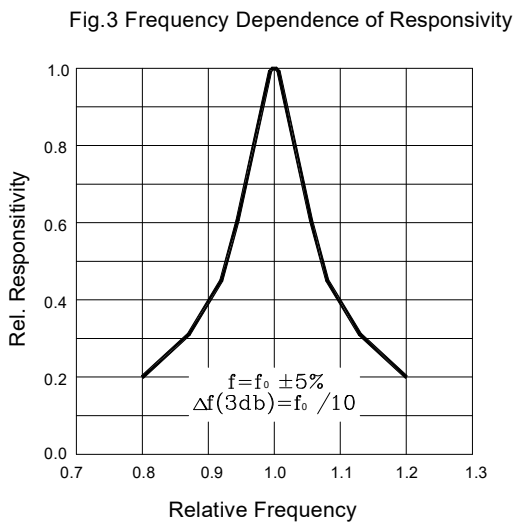
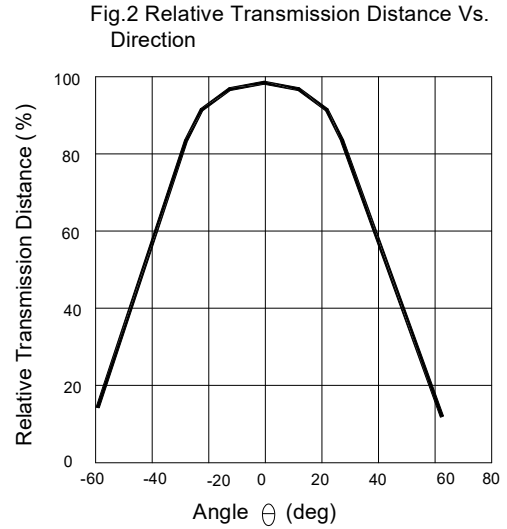
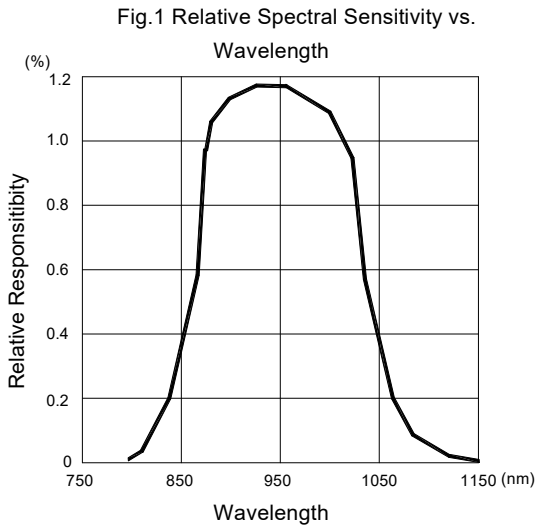
项目	符号	规格	单位
供电电压	Vcc	0.0-6.0	V
供电电流	Icc	0-2.5	mA
工作温度	Topr	-40-80	°C
储存温度	Tstg	-45-125	°C
焊接温度*	Tsol	260	°C

注(Notes): *焊接时间 $t < 5s$, 回流焊接时间 $t < 10s$

六、可接收的码型列表 Acceptable code list

码型 data format	可接受代码 code acceptable
NEC	O
RC5_Philips	O
RC6_Philips	O
RCA_Thomson	X
Toshiba	O
Sharp	O
Sony 12 Bit	O
Sony 15 Bit	X
Sony 20Bit	X
Matsushita	O
Mitsubishi	O
Zenith	O
JVC	O
Continuous code	X
High Data Rate code	X

七、典型光电特性曲线图 Typical photoelectricity characteristic curve chart: ($T_a=25^\circ\text{C}$)

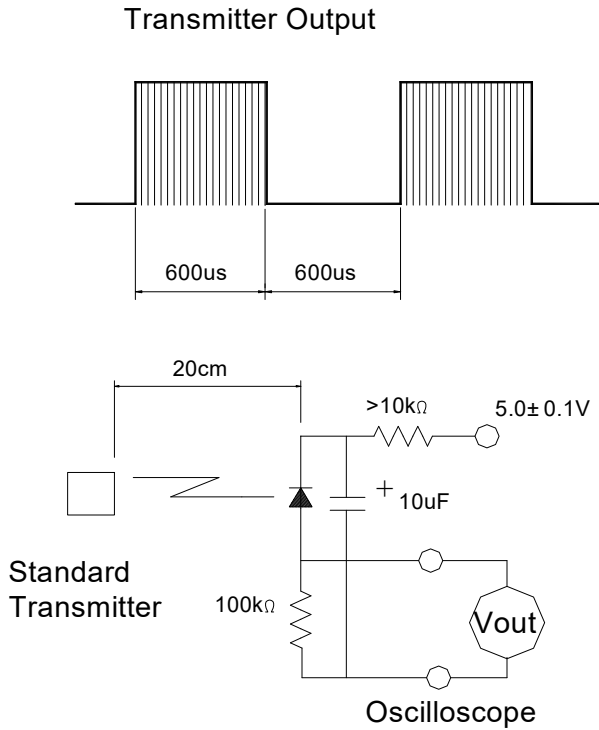


ESD Test Results

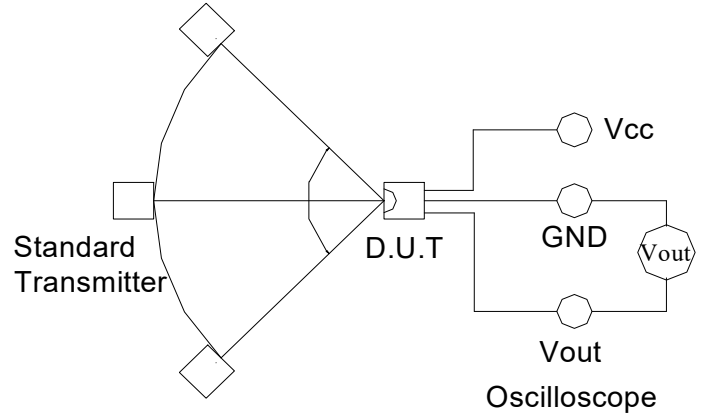
Parameter	Specification	Results
Machine Model	Min $\pm 200\text{V}$	$> \pm 400\text{V}$
Human Body Model	Min $\pm 2000\text{V}$	$> \pm 4000\text{V}$
Charged Device Model	Min $\pm 400\text{V}$	$> \pm 600\text{V}$

八、测试方法

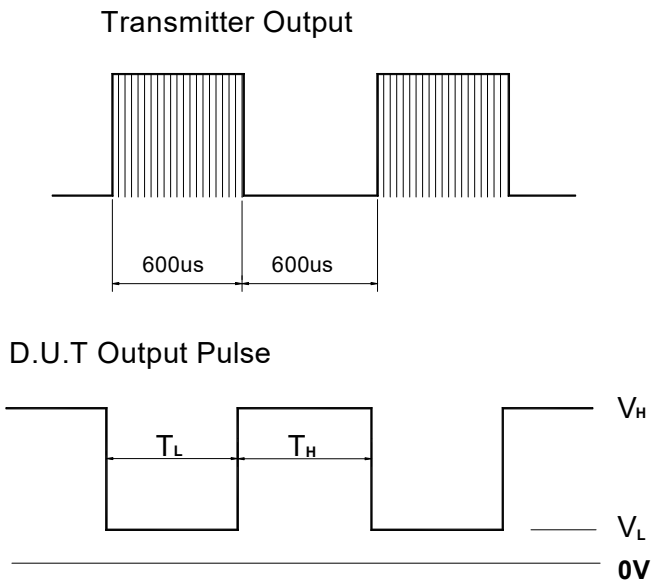
A. Standard Transmitter



B. Detection Length Test



C. Pulse Width Test

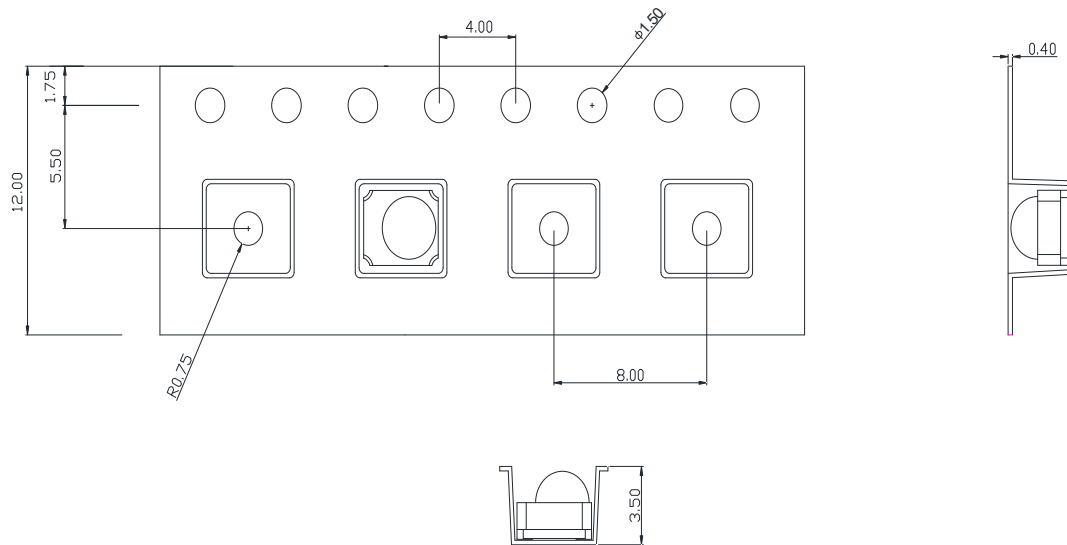


九、可靠性实验项目 Reliability Test Project:

描述 Description	项目 Item	测试标准 Test criterion	测试条件 Test condition	测试时间 Test time	数量 Qty.	失效数量 Fail Qty.
寿命测试 Life test	常温寿命测试 Life test (room temperature)	JIS7021:B4	Ta=25°C±5°C, IF=20mA	1000Hrs	22	0
环境测试 Ambience test	高温存储 High temperature store	JIS7021:B10 MIL-STD-202:210A MIL-STD-750:2031	Ta=85°C±5°C	1000Hrs	22	0
	低温存储 Low temperature store	JIS7021:B12	Ta= -35°C±5°C	1000Hrs	22	0
	高温高湿测试 High temperature/ humidity test	JIS7021:B11 MIL-STD-202:103D	Ta=85°C±5°C RH=85%	1000Hrs	22	0
	冷热冲击测试 Cold / Heat strike test	JIS7021:B4 MIL-STD-202:107D MIL-STD-750:1026	30min -10°C±5°C ←→ 100°C±5°C 5min 5min	50Cycles	22	0
	冷热循环测试 Cold and heat cycle test	JIS7021:A3 MIL-STD-202:107D MIL-STD-705:105E	5min 5min 5min -35°C ~ 25°C ~ 85°C ~ -35°C 30min 5min 30min 5min	50Cycles	22	0

十、包装载带与圆盘尺寸 Package carrier and disk dimensions

卷轴包装: 2500pcs/卷 Packing quantity: 2500 PCS/rolls



Notes: 1. All dimensions are in mm, tolerance is ± 0.2 unless otherwise noted.

十一、注意事项 Note:

1、焊接 Welding

- (1) SMD LED 灌密封胶较软，外力易损坏发光面及塑料壳，焊接时要轻拿轻放。

SMD LED is soft and easy to damage the luminous surface and plastic shell by external force It should be handled lightly when welding.

- (2) 建议使用易洗型的助焊剂，依照回流曲线条件回流焊接，回流次数最多两次，确保 LED 发光面干净，异物会影响发光颜色。

It is recommended to use soldering flux with tin wash type, reflow soldering according to the condition of reflux curve, reflow twice at most, ensure the LED luminous surface is clean, foreign matter will affect the luminous color.

- (3) **使用手工烙铁焊接**，推荐使用功率低于 25W 的烙铁，焊接时烙铁的温度必须保持在 260℃ 以下，且每个电极只能进行一次焊接，每次焊接的持续时间不得超过 3 秒。

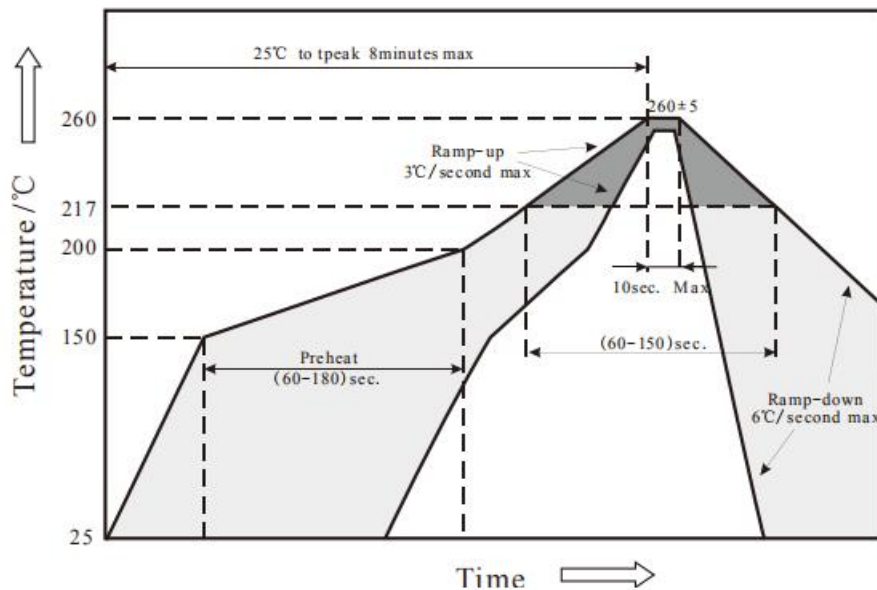
人手焊接过程中的不慎操作易引起 LED 产品的损坏，应当小心谨慎。

A soldering iron of less than 25W is recommended to be used in Hand Soldering. Please keep the temperature of the soldering iron under 260℃ while soldering. Each terminal of the LED is to go for less than 3 second and for one time only.

Be careful because the damage of the product is often started at the time of the hand soldering.

- (4) **回流焊接**：推荐使用以下无铅回流焊接温度图进行。

Reflow Soldering: Use the conditions shown in the under Figure of Pb-Free Reflow Soldering



- (5) 回流焊不能超过两次,回流焊最高温度建议 210℃。

Reflow soldering should not be done more than two times. The reflow temperature we recommend is 210℃

- (6) 焊接过程中，严禁在高温情况下碰触胶体；焊接后禁止对胶体施加外力，禁止弯折 PCB，避免元件受到撞击。

During the soldering process, do not touch the lens at high temperature, After soldering, any mechanical force on the lens or any excessive vibration shall not be accepted to apply, also the circuit board shall not be bent as well.

- (7) 在焊接完成后，待产品温度下降到室温之后，再进行其他处理。

After soldering, do not deal with the product before its temperature drop down to room temperature

- (7) 请不要将不同 BIN 级的 LED 使用于同一个产品上，否则可能会导致产品的严重色差。

Please do not use different BIN LED on the same product, otherwise it may cause serious color difference.

2、防静电措施 ESD countermeasure

(1) 静电和电涌会导致产品特性发生改变，例如正向电压降低等，如果情况严重甚至会损毁产品。所以在使用时必须采取有效的防静电措施。

Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristics such as the forward voltage becomes lower, or the LEDs can not be lighted up. In view of the above, we should do some anti-static precautions when using the SMD LED

(2) 所有相关的设备和机器都应该正确接地，同时必须采取其他防止静电和电涌的措施。
All devices, equipments and machineries must be properly grounded, at the same time we should take measures to prevent anti-static and voltage surge.

(3) 使用防静电手环，防静电垫子，防静电工作服、工作鞋、手套，防静电容器，都是有效的防止静电和电涌的措施。

It is also recommended that anti-electrostatic wrist bands, pads, uniforms, gloves or containers can be used when dealing with the LEDs

3、反压保护 Reverse voltage protection

通常 LED 的反向漏电流都很小，不会影响正常使用。如果 LED 长期遭受超过其所能承受的反向电压冲击时，LED 会被损伤，例如，反向漏电流会迅速变大等。这样会引起显示屏零灰度下串光的发生。在设计中，要注意控制反向电压，建议加在 LED 上的反向电压值不超过 10V。

In general, the reverse current of LED is very small, which won't affect the normal use of components. But when it is often suffered the reverse voltage which exceeds the limit of the component then it will be damaged. Such as the reverse current increase rapidly. And it will cause the string light when the screen is black. So please pay attention to controlling the reverse voltage which less than 10V is recommended.

4、清洗 Cleaning

在焊接后推荐使用酒精（无水乙醇）进行清洗，在温度不高于 30℃的条件下持续 3 分钟，不高于 50℃的条件下持续 30 秒。使用其他类似溶剂清洗前，请先确认使用的溶剂不会对 LED 的封装和环氧树脂部分造成损伤。

It is recommended that alcohol (Anhydrous ethanol) be used as a solvent for cleaning after soldering. Cleaning is to go under 30℃ for 3 minutes or 50℃ for 30 seconds. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not.

5、灌封 Embedment

(1) 挥发性物质会渗透到 LED 内部，在通电产生光子及热的条件下，会导致 LED 变色，进而造成严重光衰，严禁使用任何对 LED 器件的性能或者可靠性有害的物质或材料，针对特定的用途和使用环境，建议对所有的物质和材料进行相容性的测试。在贴装 LED 时候，不要使用能产生有机挥发性气体的粘结剂。

Volatile substances to leach into the LED inside, photons in electricity and heat conditions, will lead to the LED color, thus causing serious droop, it is forbidden to use any of the LED device performance or reliability of harmful substances or materials, for a specific purpose and use of the environment, advice on all the material and the material compatibility test. When attaching LED, do not use adhesive that can produce volatile organic gas.

(2) 使用正常灌封胶时,建议先以少量试验，常温点亮 168 小时，确定没有问题再作业。

It is recommended to light up for 168 hours at room temperature for a small amount of test before using normal filling and sealing glue.

6、存储时间 Storage time

为避免受潮的影响，我司建议产品在未开包装前储存条件为 5-30°C，相对湿度小于 60%；已开包装的 LED 光源请在 24H 内使用安装完毕，如未用完之产品，请进行除湿并抽真空后密封保存。开封超过一周或湿度卡发生变化时，请务必进行除湿，除湿条件：60°C±5°C，12H；产品密封保存有效使用期为一年。

To avoid moisture, we recommend storage conditions for the unopened LED +5 ~ +30 °C, relative humidity <60%. LED should be used within 24 Hrs. of opening the package. Please make sure to dehumidify and vacuum pack the remaining/unused LED. Dehumidifying condition: +60 °C ± 5 °C, 12 Hrs. Effective age for the sealed led is one year.

7、使用注意事项 Precautions

(1) 直接用手拿取产品不但会污染封装树脂表面，也可能由于静电等因素导致产品性能的改变。过度的压力也可能直接影响封装内部的管芯和金线，因此请勿对产品施加过度压力，特别当产品处于高温状态下，例如在回流焊接过程中。

When handling the product, touching the encapsulation with bare hands will not only contaminate its surface, but also have an effect on its optical characteristics. Excessive force to the encapsulation might result in catastrophic failure of the LEDs due to die breakage or wire deformation. For this reason, please do not put excessive stress on LEDs, especially when the LEDs are heated such as during Reflow Soldering.

(3) 产品在进行 PCB 布线设计时，针对软性板材、及 0.5T 以下板材，焊盘走向应与 PCB 延展方向保持垂直状态，以减少 PCB 板弯折时产生之应力作用在 LED 引脚，造成 LED 产品因应力作用拉伸产生失效隐患；

In PCB wiring design, for soft plates and plates below 0.5T, the direction of the pads should be kept perpendicular to the direction of PCB extension, so as to reduce the effect of the bending stress of the PCB on the LED pins, resulting in the potential failure of LED products due to stress stretching

(4) LED 的环氧树脂封装部分相当脆弱，请勿用坚硬、尖锐的物体刮、擦封装树脂部分。在用镊子夹取的时候也应当小心注意。

The epoxy resin of encapsulation is fragile, so please avoid scratch or friction over the epoxy resin surface. While handling the product with tweezers, do not hold by the epoxy resin, be careful.



8、其他 Others

(1) 依规格要求，本公司保留调整产品材料组合的权利。

TONYU reserves the rights on the adjustment of product material mix for the specification.

(2) 如果超出规格书以外而进行使用时，出任何问题我们都将不承担责任。

We will not be responsible for any problem if it is used beyond the specification.

(3) 在使用产品之前，应与我们交流，了解更详细的规格要求。

Before using the product, you should communicate with us for more detailed specifications.